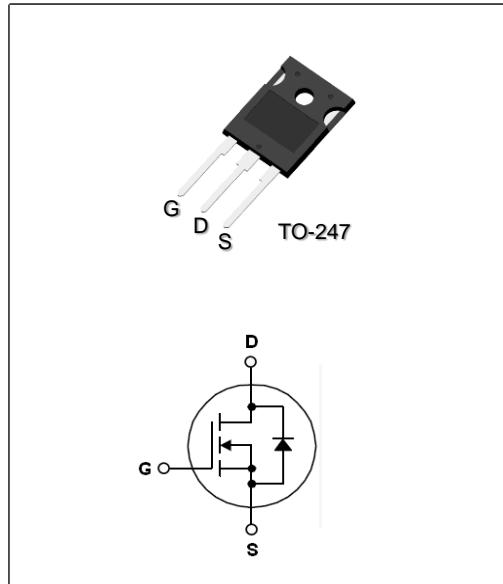


## 300V 59A N-Channel Enhancement Mode Power MOSFET

### Description

The AKT59N30H is an N-Channel enhancement mode power MOSFET which using proprietary planar stripe and DMOS technology, it has extremely low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for switched mode power supplies.



### Features

- Advanced Trench Technology
- Typical on-Resistance:  $R_{DS(on)}=55\text{m}\Omega$  @  $V_{GS}=10\text{V}$ ,  $I_D=59\text{A}$
- Rated Avalanche Energy
- RoHS Compliant

### Applications

- Switched Mode Power Supplies
- Motor Control
- Synchronous Rectification

### Absolute Maximum Ratings @ $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter		Ratings	Unit
$V_{DSS}$	Drain to Source Voltage		300	V
$V_{GSS}$	Gate to Source Voltage		$\pm 25$	V
$I_D$	Drain Current		$59$	A
	$T_C=100^\circ\text{C}$		$35$	A
$I_{DM}$	Pulsed Drain Current (Note1)		236	A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	500	W
	Derate above $25^\circ\text{C}$		4	W/ $^\circ\text{C}$
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)		2800	mJ
$T_J$	Operating Junction Temperature Range		-55~+150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55~+150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	0.25	$^\circ\text{C}/\text{W}$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^\circ\text{C}/\text{W}$

**Electrical Characteristics** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	250	-	-	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	3.0	3.35	4.0	V
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=29.5\text{A}$	-	55	-	$\text{m}\Omega$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0\text{V}$	-	-	$\pm 100$	nA

**D-S Diode Characteristics and Maximum Rating** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Maximum Drain to Source Diode Forward Current		-	-	59	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=59\text{A}$	-	1.0	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{GS}=0\text{V}, I_S=59\text{A}, \frac{dI}{dt}=-100\text{A}/\text{us}$	-	245	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	5.9	-	$\mu\text{C}$

**Switching Characteristics** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=59\text{A}, V_{DD}=150\text{V}, V_{GS}=10\text{V}, R_G=25\Omega$ (Note 3)	-	135	-	ns
$t_r$	Rise Time		-	550	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	120	-	ns
$t_f$	Fall Time		-	190	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$	-	3450	4560	pF
$C_{oss}$	Output Capacitance		-	650	870	pF
$C_{rss}$	Reverse Transfer Capacitance		-	78	110	pF
$Q_g$	Total Gate Charge	$I_D=59\text{A}, V_{DS}=240\text{V}, V_{GS}=10\text{V}$ (Note 3)	-	74	-	nC
$Q_{gs}$	Gate to Source Charge		-	21	-	nC
$Q_{gd}$	Gate to Drain Charge		-	40	-	nC

**Note:**

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $V_{DD}=100\text{V}, L=2\text{mH}, V_G=10\text{V}, I_{AS}=57\text{A}$
3. Essentially independent of operating temperature typical characteristics

## Typical Performance Characteristics

Fig. 1. Typical on-Resistance Characteristics

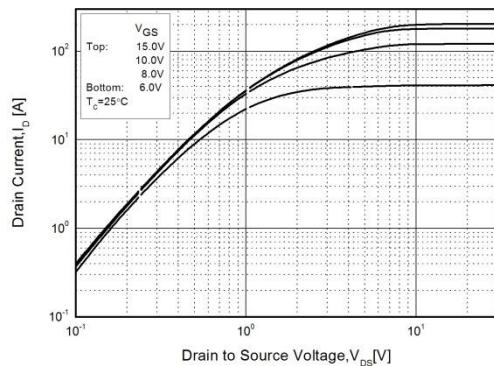


Fig. 3. Static on-Resistance vs.  $I_D$

Fig. 2. Typical Transfer Characteristics

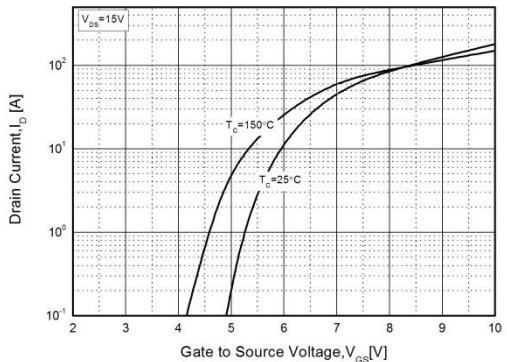


Fig. 4. Body Diode Forward Voltage vs.  $I_{DR}$

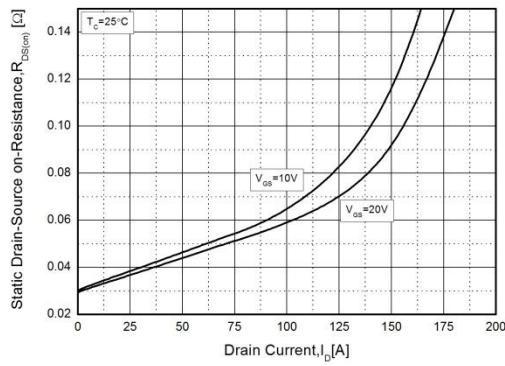


Fig. 5. Capacitance Characteristics

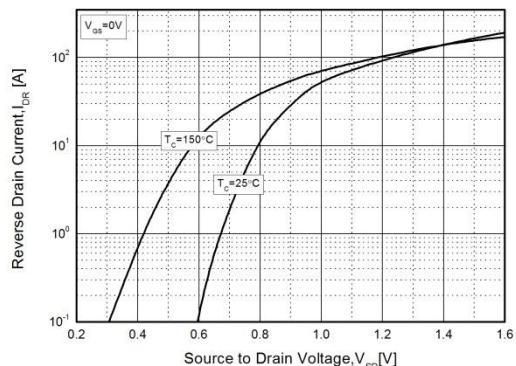
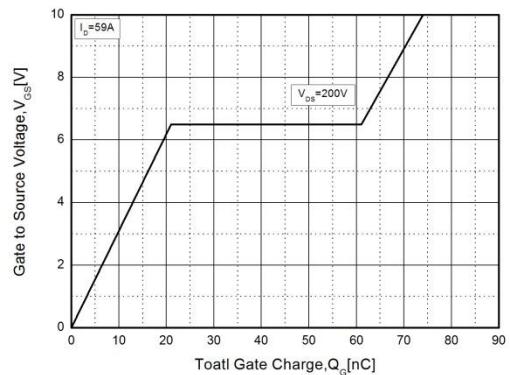
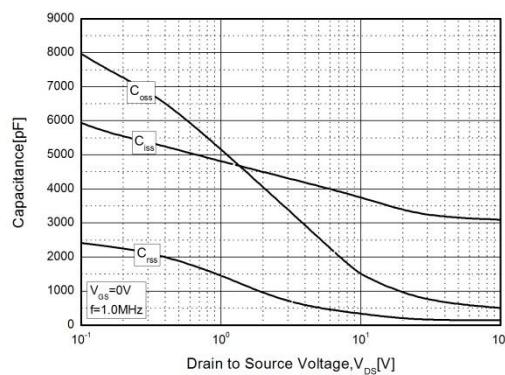


Fig. 6. Gate Charge Characteristics



## Typical Performance Characteristics

Fig. 7. Breakdown Voltage vs. Temperature

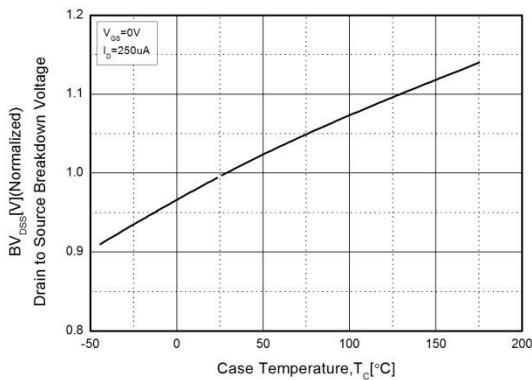


Fig. 8. Static on-Resistance vs. Temperature

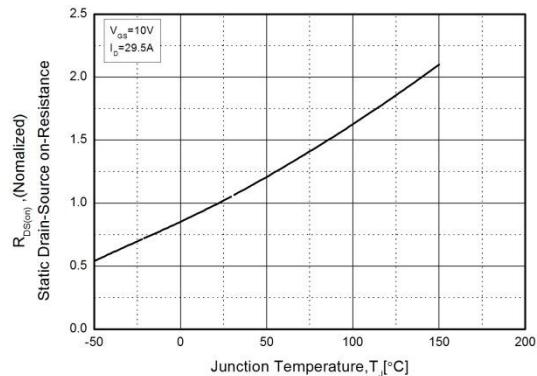


Fig. 9. Maximum Safe Operating Area

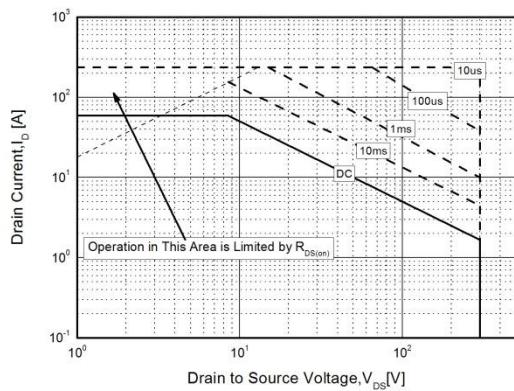


Fig. 10. Maximum Drain Current vs. Temperature

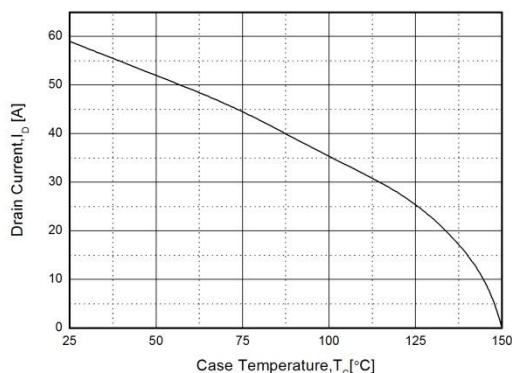
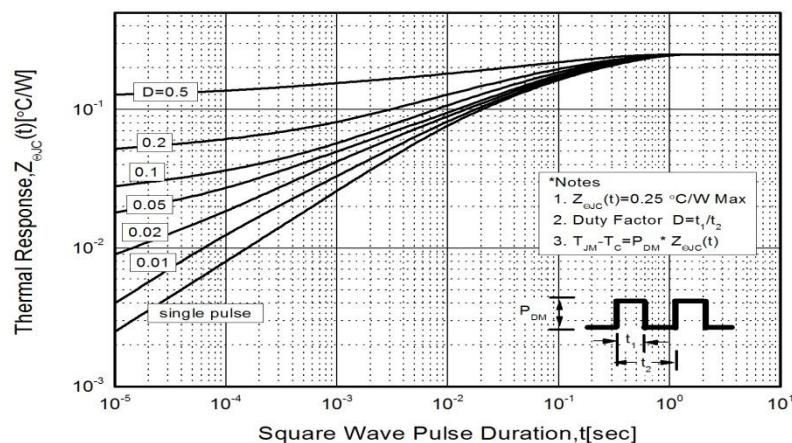


Fig. 11. Transient Thermal Response Curve



**Package Dimensions****TO-247**

(Dimensions in Millimeters)

